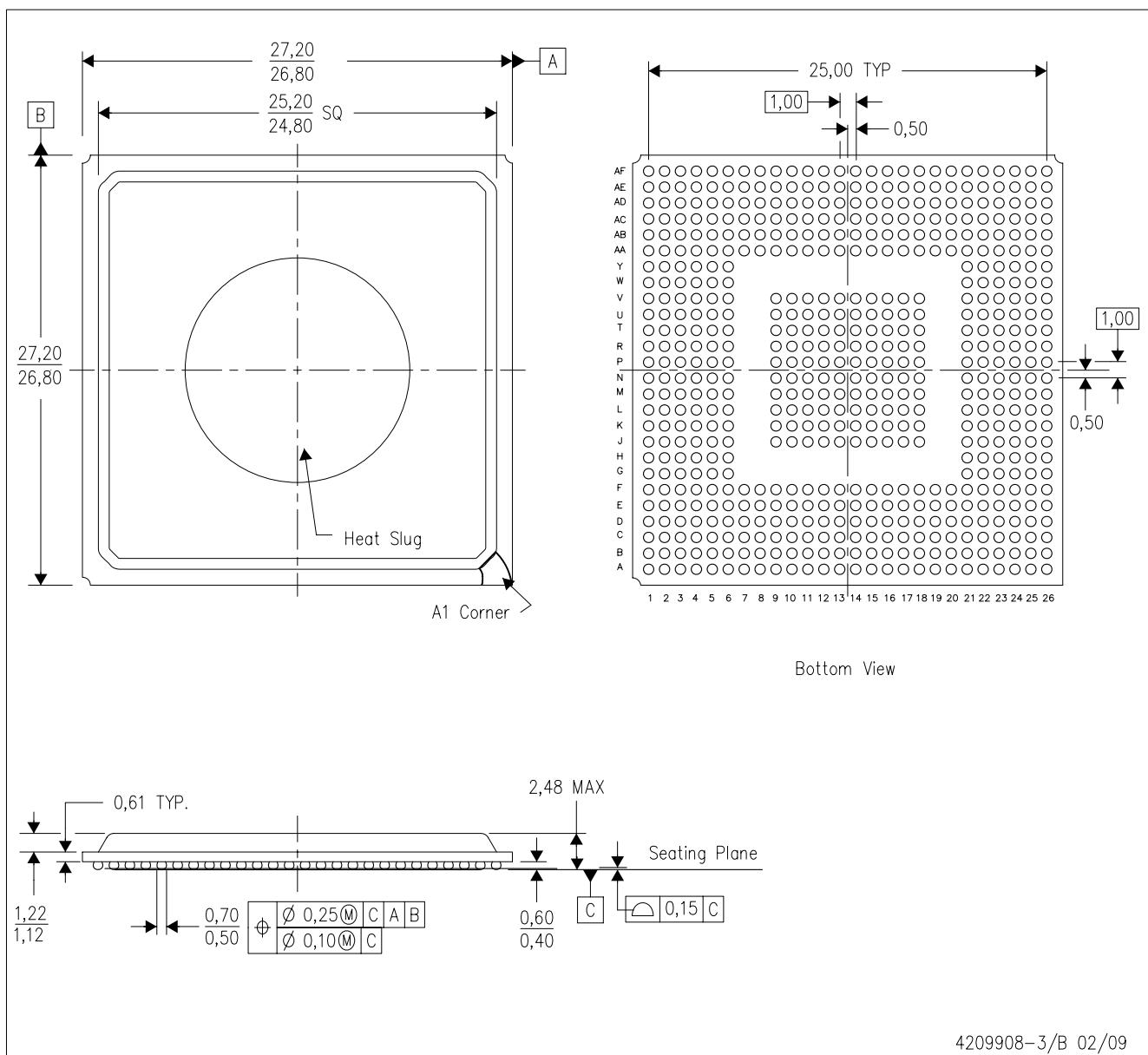


MECHANICAL DATA

ZEQ (S-PBGA-N580)

PLASTIC BALL GRID ARRAY



NOTES:

- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- This drawing is subject to change without notice.
- Thermally enhanced plastic package with heat slug (HSL).
- This is a Pb-free solder ball design.

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